

28-29 September 2010

#### **SET-171 Mid-IR Fiber Laser Workshop**

Scaling of fiber laser systems based on novel components and high power capable packaging and joining technologies

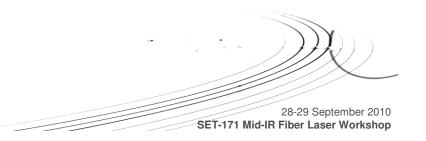


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**Report Documentation Page** 

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### **Outline**



- introduction
- packaging and joining technologies
  - Application to microchip lasers
- novel components
  - Applications to fiber laser system scaling
- example of MID-IR source
- possible further directions

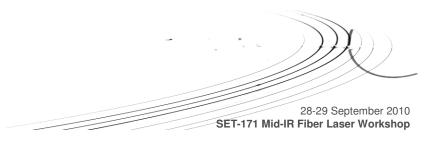




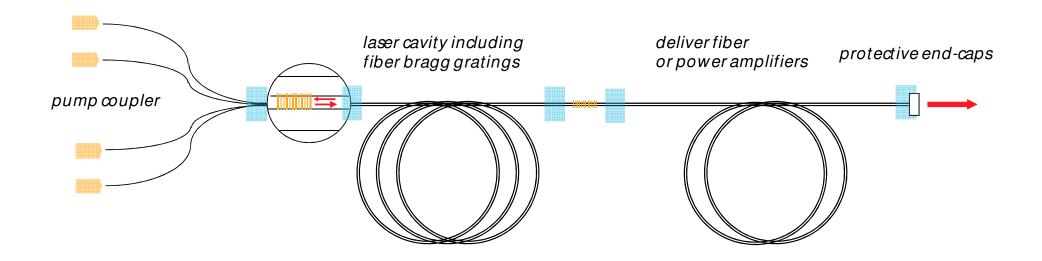


### **Fiber Laser**

### Introduction



- fiber lasers and amplifiers
  - high gain, excellent and power independent beam quality



all fiber setup for stability

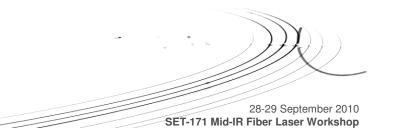




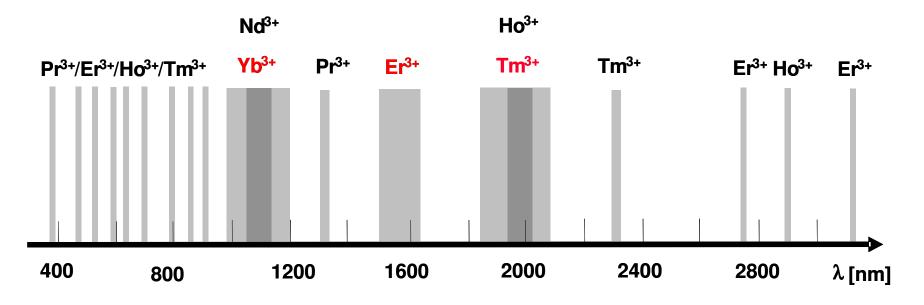


#### **Fiber Laser**

### Introduction



rare-earth doped fibers, kW average power levels available



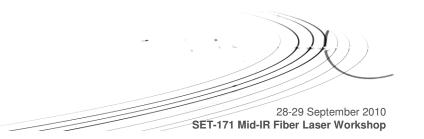
long wavelength by heavy metal cation fibers (e.g zirconium, ZBLAN fibers), which are not as "stable" as fused silica)







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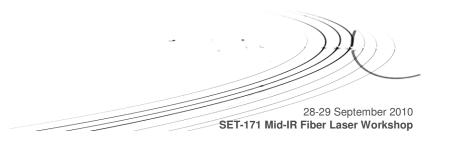




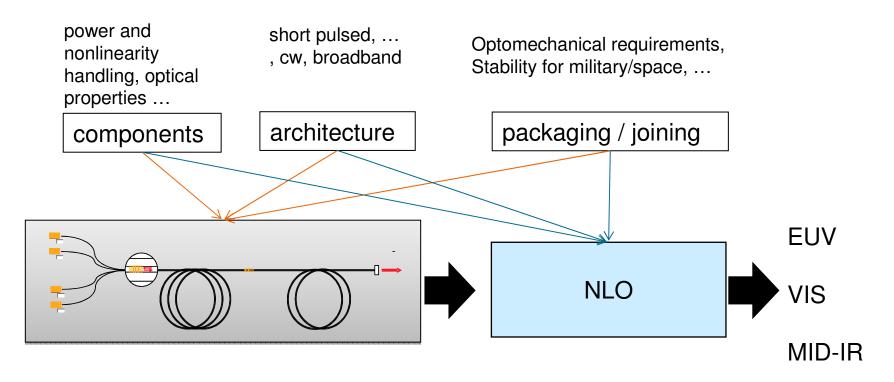


### **Fiber Laser**

### Introduction



designing a (Mid-IR) source ...

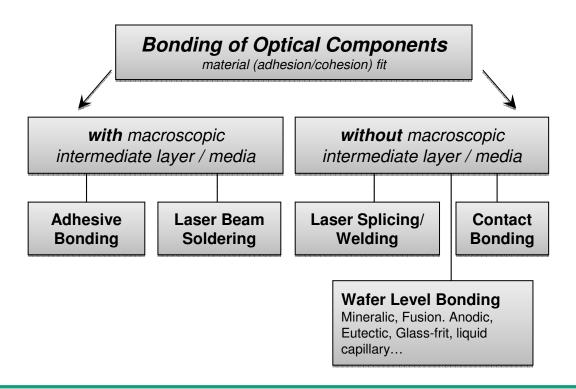




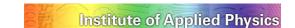


# **Overview of Joining Technologies** for Optoelectronic Packaging

- Bonding of different materials always required
- material, thermal or optical contact desired





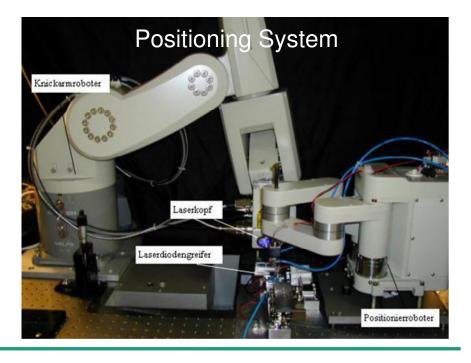




### **Adhesive Bonding**

- Alignment of a Micro Lens Array to a CCD Sensor
  - 6 degrees of freedom
  - Alignment step wide: 0,1 1 µm





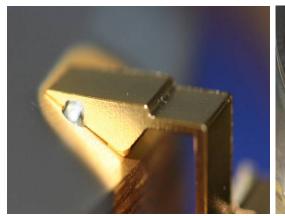






### **Laser Soldering**

- long term stability
- high temperature stability
- high radiation stability compared to adhesives
- good vacuum compatibility / no outgasing
- high thermal and electrical conductivity
- flux free processing due to sputtered thin film metallization
- flexible and automated assembly





laser beam soldered optics for lithography





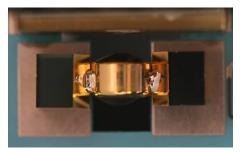


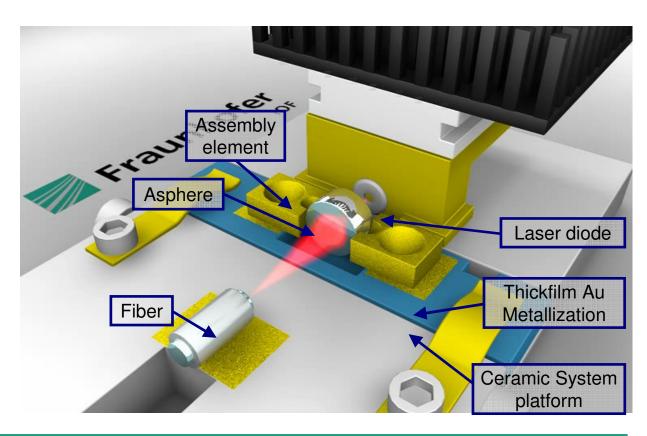
# **Solder Bumping**

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Example of fiber coupled diode













### **Mineralic Bonding**

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inorganic bonding at low temperatures (≤ 200 °C) using special silicate solutions

- e.g. for high precision optical & mechanical systems
- high stability (intermediate layer <200nm)</p>
  - low stress
  - "cold" bonding
  - NO creep
  - NO "out-gassing"







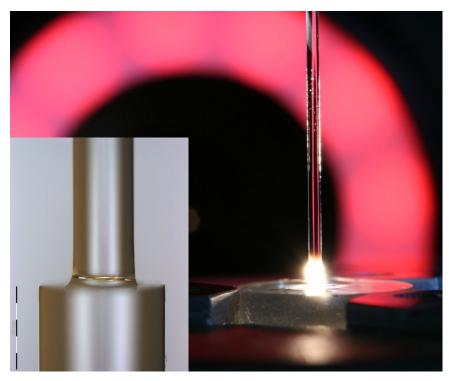




### Laser based splicing and tapering

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- Tapering and splicing device as well as process control developed
- easy adaptable
- very precise joints
- computer controlled process with high joining reproducibility
- mechanical stable welded joints
- high purity process without contaminations
- very low optical losses
- no consumables like process gas or filaments



Multimode fiber (Ø720µm) with spliced end cap (Ø1500µm)

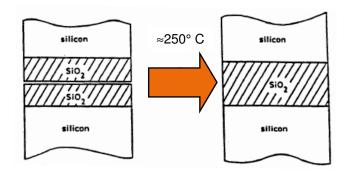


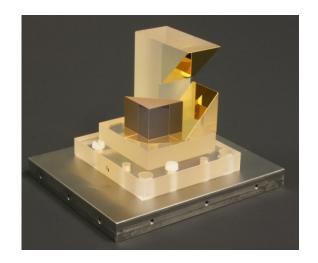




### **Direct bonding**

- Without additional material surface activation
- direct bond by a Waals forces
- very small tolerances
- jonts are sensitive to shock
- adjustment only within the plane of joining
- assemblies tested under vacuum and cryogenic environment







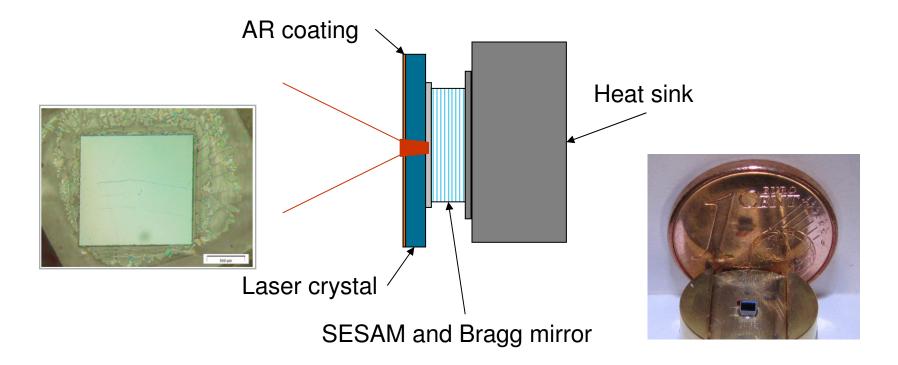




# Novel components and laser systems

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Microchip laser system using bonding technology





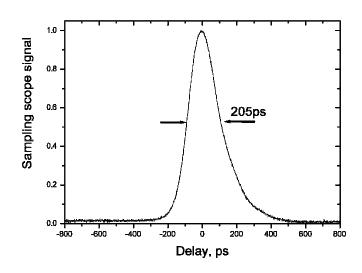


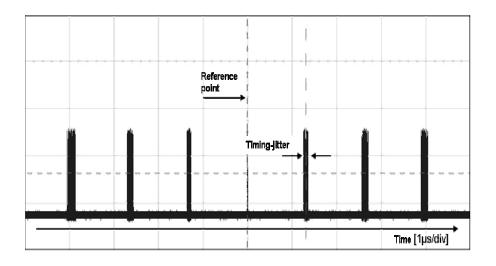


# Novel components and laser systems

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- Microchip laser system using bonding technology
  - Unwanted jitter (typical for Q-switched lasers)





200 ps, Slope efficiency of ~ 35%, Ep = 120 -140 nJ, Repetition rate up to 2 MHz



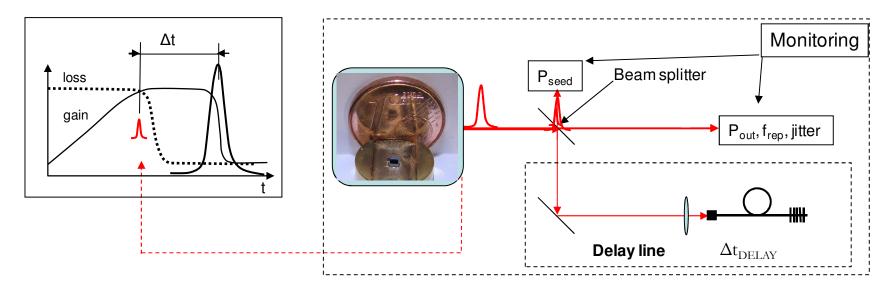




# Novel components and laser systems

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- Microchip laser system using bonding technology
  - Unwanted jitter (typical for Q-switched lasers)
  - Self-injection seeding



A.Steinmetz et al. Applied Physics B (2009) 97: 317-320

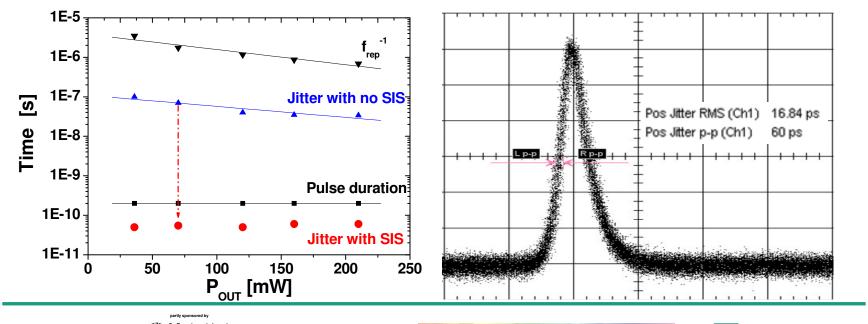






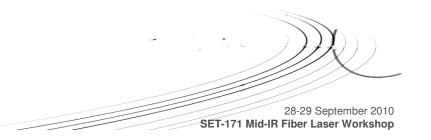
### Novel components and laser systems

- Microchip laser system using bonding technology
  - Unwanted jitter (typical for Q-switched lasers)
  - Self-injection seeding
  - Low cost alternative to mode-locked lasers





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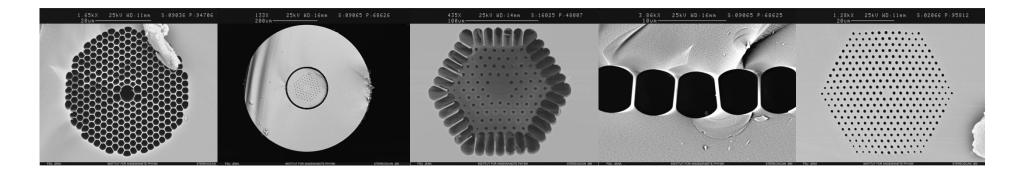






# Scaling of fiber laser systems Novel components and laser systems

- components:
  - novel fiber designs







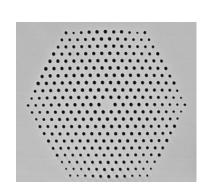
### Novel components and laser systems

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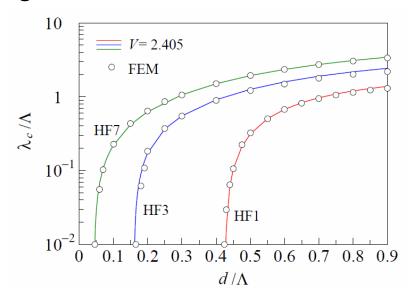
#### components:

novel fiber designs = novel optical properties

#### endlessly single mode

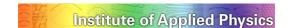


- MFD independent of  $\lambda$
- SM from 0.5 to 2.5 μm



Kunimasa Saitoh, Yukihiro Tsuchida, Masanori Koshiba, and Niels Asger Mortensen, "Endlessly single-mode holey fibers: the influence of core design," Opt. Express 13, 10833-10839 (2005)

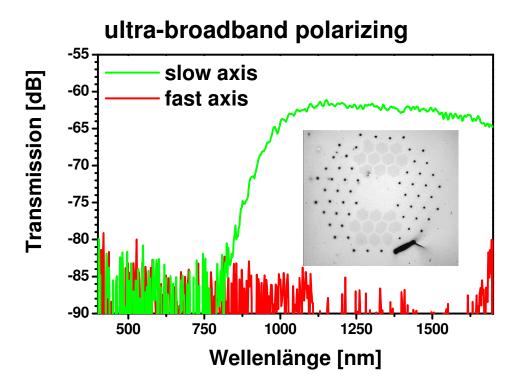






### Novel components and laser systems

- components:
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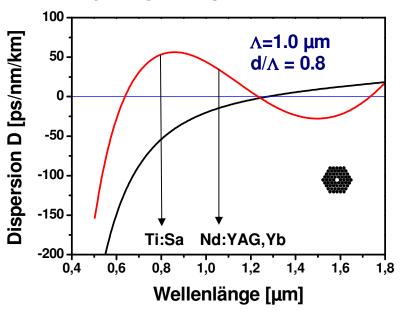


### Novel components and laser systems

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- components:
  - novel fiber designs = novel optical properties

### extremly large dispersion shifts



enhanced nonlinearity

 $A_{eff}$ ~1..2  $\mu m^2$ 





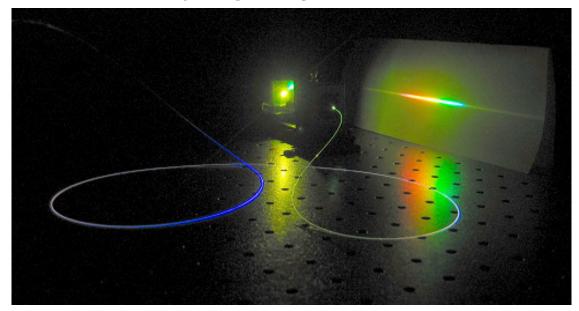


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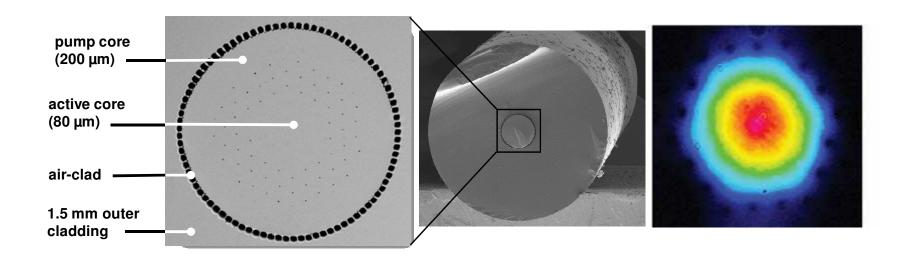


### Novel components and laser systems

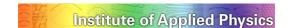
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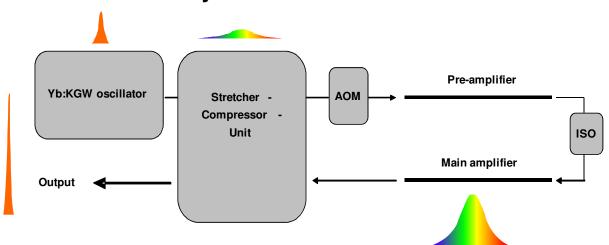


### Novel components and laser systems

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- components:
  - novel fiber designs = novel optical properties

#### extremly low nonlinear interaction



- First GW fiber femtosecond system
- First kW average power fiber femtosecond system





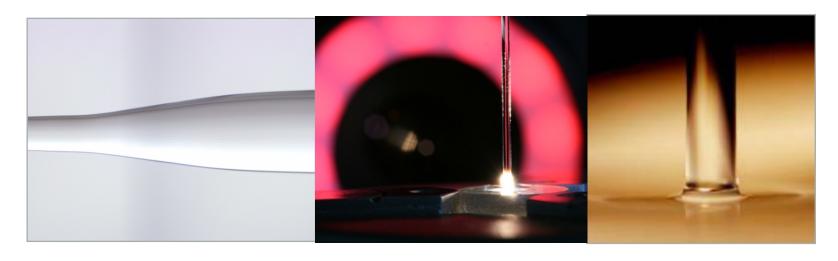


# Novel components and laser systems

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- components:
  - novel fiber designs = novel optical properties
  - fiber compatible components

### tapers and endcaps







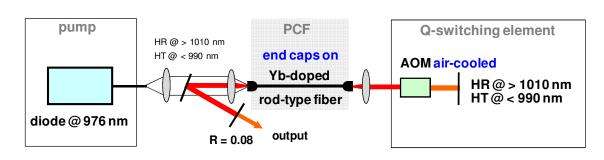


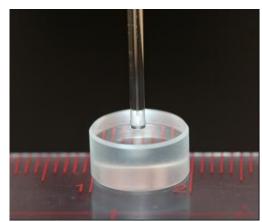
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#### tapers and endcaps





mJ, ns fiber laser systems





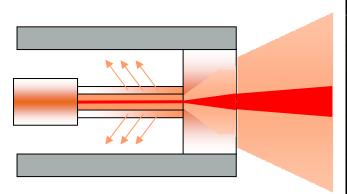


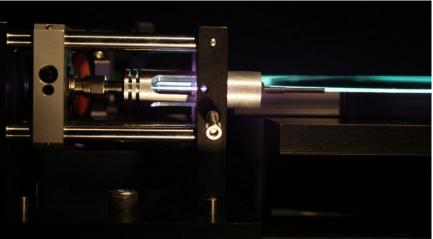
# Novel components and laser systems

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- components:
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  - fiber compatible components

#### mode-stripper and high power connector









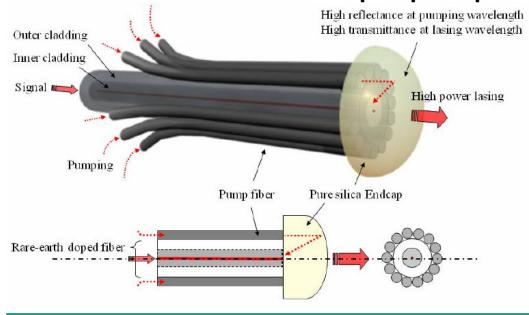


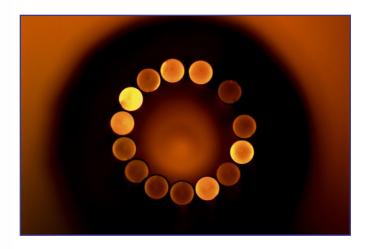
### Novel components and laser systems

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- components:
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  - fiber compatible components

#### **Novel pump couplers**









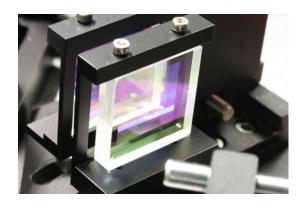


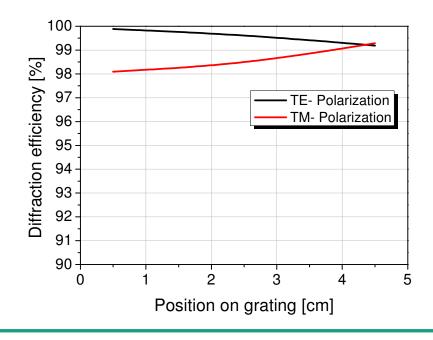
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#### components:

- novel fiber designs = novel optical properties
- fiber compatible components
- High power components









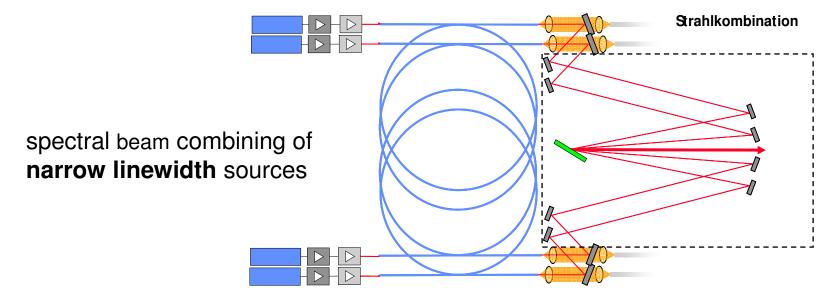


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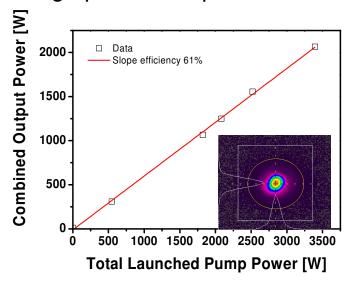


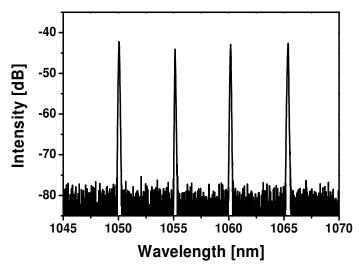
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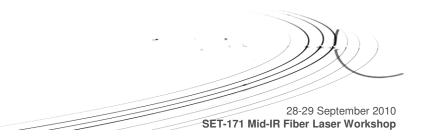
C. Wirth, O. Schmidt, I. Tsybin, T. Schreiber, T. Peschel, F. Brückner, T. Clausnitzer, J. Limpert, R. Eberhardt, A. Tünnermann, M. Gowin, E. ten Have, K. Ludewigt, and M. Jung, "2 kW incoherent beam combining of four narrow-linewidth photonic crystal fiber amplifiers," Opt. Express 17, 1178-1183 (2009)







### **Outline**



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  - Application to microchip lasers
- novel components
  - Applications to fiber laser system scaling
- **■** example of MID-IR source
- possible further directions
- summary



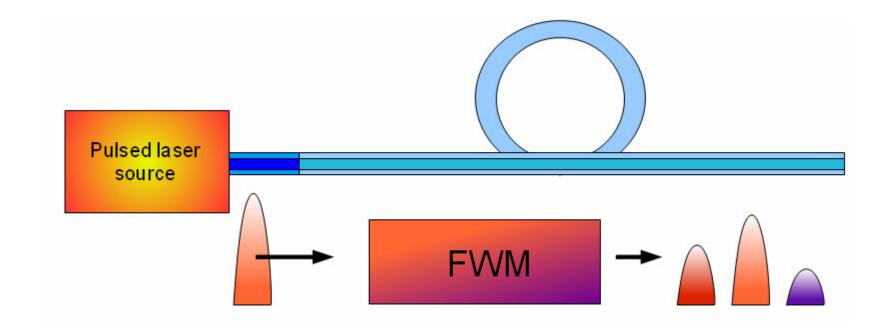




# Novel components and laser systems

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Approach for a fiber based picosecond VIS and MIR source

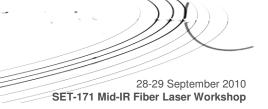








# Novel components and laser systems

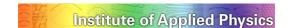


Approach for a fiber based picosecond VIS and MIR source

#### **Degenerated FWM**

a)	$2\omega_1 = \omega_2 + \omega_3$	Energy conservation
b)	$2k_{pump} = k_{signal} + k_{idler} + \gamma P_1 = 0$	momentum conservation
c)	Low losses at $\omega_1$ , $\omega_2$ and $\omega_3$	No attenuation of the waves
d)	MFD <sub>Signal</sub> ≈ MFD <sub>Pump</sub> ≈ MFD <sub>Idler</sub>	Good overlap of the involved waves







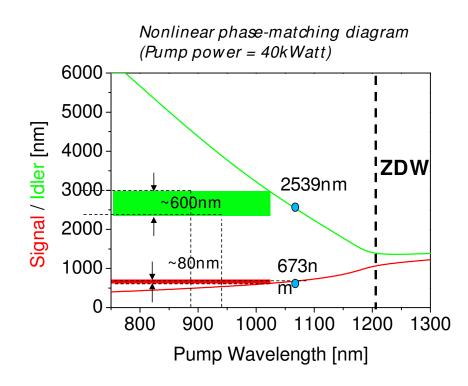
### Novel components and laser systems

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Approach for a fiber based picosecond VIS and MIR source

Condition a) 
$$2\omega_1 = \omega_2 + \omega_3 + \omega_3$$

b) 
$$2k_{pump}=k_{signal}+k_{idler}+\gamma P_1=0$$



To get widely separated signals move the pump wavelength far away from the ZDW (in the normal dispersion regime)

Furthermore, the amplification bandwidth is given by:

$$\Omega_A \approx \frac{\gamma P_O}{|\beta_2|\Omega_S}$$

Thus, additionally to get narrowband signals we need:

- high dispersion
- high separation of the wavelengths







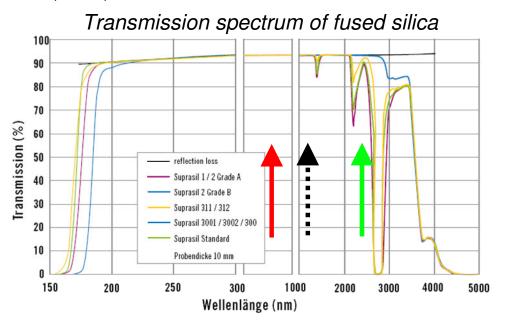
### Novel components and laser systems



Approach for a fiber based picosecond VIS and MIR source

Condition c) Low losses at  $\omega_2$  and  $\omega_3$ 

Analyze the phase-matching condition a) and b) and look for a material which transmission window fullfils c)



IR graded fused silica is a good candidate to use with tunable lasers from 1020-1090nm!







www.hereaus.de

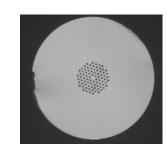
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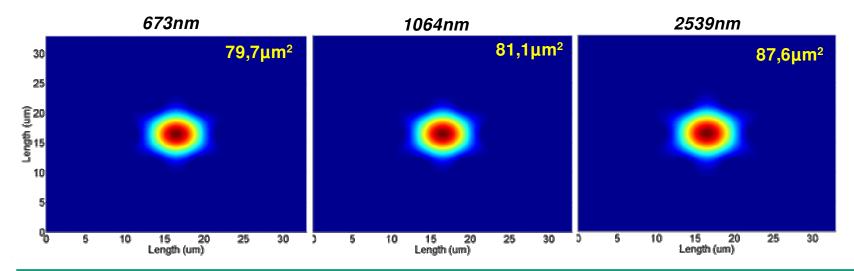
Approach for a fiber based picosecond VIS and MIR source

Condition d)  $MFD_s \approx MFD_p \approx MFD_i$ 

Use an **endlessly single mode design** to ensure good mode field overlap for all involved wavelengths. E.g. an LMA-10 PCF.



Mode field distribution in LMA-10 fiber for signal, pump and idler waves:





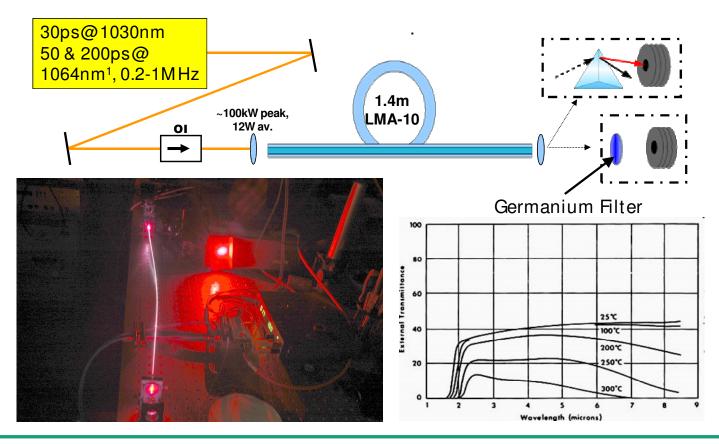




# Novel components and laser systems

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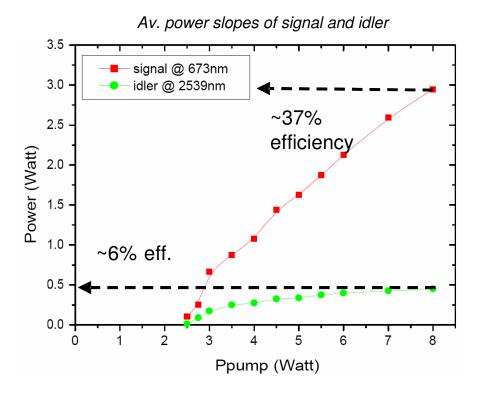


### Novel components and laser systems

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Approach for a fiber based picosecond VIS and MIR source

Slopes of the signal and idler wave average power with 200ps pulses and 1MHz rep. rate.







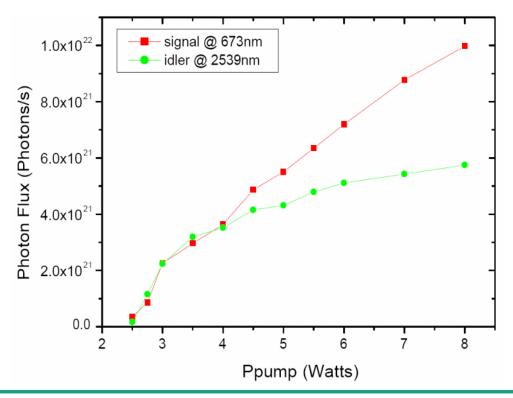


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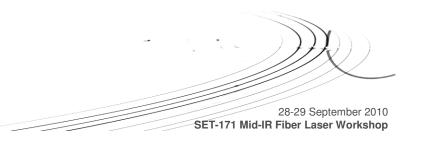






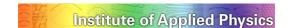


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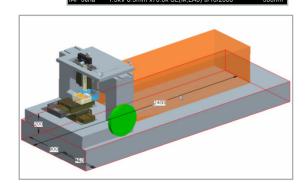


### Packaging and Joining Technologies for fiber lasers - further directions

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- using other NLO-elements + high power silica fiber lasers
  - e.g. quasi phase-matching (orientation-patterned GaAs)
  - transparent (low absorption), nonlinear materials + bonding process (for thermal contact)
- anti-reflection properties on MID-IR fibers
  - effective media directly bonded to fiber end facet
- fiber bragg gratings
  - written by femtosecond pulses (for non UV-sensitive fibers)













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Scaling of fiber laser systems based on novel components and high power capable packaging and joining technologies

